HOV 2 6 2004 CS

AP/1753/94 0.40269X00 CC

N THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants

HABA et al.

Application No.:

09/888,642

Filed

26 June 2001

For

ELECTRIC COPPER PLATING LIQUID AND PROCESS FOR

MANUFACTURING SEMICONDUCTOR INTEGRATED

Art Unit

1753

Examiner

E. Wong

Conf. No.

9091

## PETITION FOR EXTENSION OF TIME

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 November 26, 2004

Sir:

In the matter of the above-identified application, Applicants hereby respectfully petition for an extension of time to permit filing a response within the first month subsequent to expiration of the period set upon filing the Notice of Appeal filed on August 25, 2004. A Credit Card Payment Form including the amount of \$110.00 to cover the required fee for the requested extension of time is attached hereto.

11/29/2004 FMETEKI1 00000009 09888642

01 FC:1251

110.00 DP

It is respectfully requested that any shortage in the fee be charged to the account of Antonelli, Terry, Stout & Kraus, LLP, Account No. 01-2135 (Case No. 500.40269X00).

Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

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